

550V N-Channel MOSFET

FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

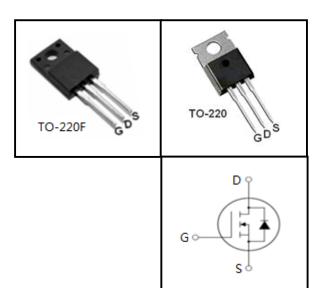
APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information			
Device	Package	Marking	
CS7N55F	TO-220F	CS7N55F	
CS7N55P	TO-220	CS7N55P	

Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted					
Parameter		Symbol	Va	Unit	
			TO-220F	TO-220	– Unit
Drain-Source Voltage ($V_{GS} = 0V$)		V _{DSS}	550		V
Continuous Drain Current		I _D	7		А
Pulsed Drain Current	(note1)	I _{DM}	28		A
Gate-Source Voltage		V _{GSS}	±	30	V
Single Pulse Avalanche Energy	(note2)	E _{AS}	112		mJ
Avalanche Current	(note1)	I _{AS}	4.8		A
Repetitive Avalanche Energy	(note1)	E _{AR}	67		mJ
Power Dissipation (T _C = 25 ^o C)		P _D	25	70	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+150		°C

Thermal Resistance				
Peremeter	Symbol	Va	Unit	
Parameter	Symbol	TO-220F	TO-220	- Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	5	1.78	K/W
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	60	r./ v v





CS7N55F, CS7N55P

Specifications $T_J = 25^{\circ}C$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Value			11	
		Test conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_{D} = 250 \mu A$	550			V	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 550V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μA	
Gate-Source Leakage	I _{GSS}	V_{GS} = $\pm 30V$			±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3		4	V	
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	V _{GS} = 10V, I _D =3.5A		1.1	1.3	Ω	
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0V,		603		pF	
Output Capacitance	C _{oss}	$V_{DS} = 25V,$		71			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		10			
Total Gate Charge	Q _g			19		nC	
Gate-Source Charge	Q_gs	$V_{DD} = 440V, I_D = 7A, V_{GS} = 10V$		3.2			
Gate-Drain Charge	Q_{gd}	55		9			
Turn-on Delay Time	t _{d(on)}			37			
Turn-on Rise Time	t _r	V _{DD} = 275V, I _D = 7A,		19		ns	
Turn-off Delay Time	t _{d(off)}	$R_{\rm G} = 25 \Omega$		82			
Turn-off Fall Time	t _f			40			
Drain-Source Body Diode Character	istics						
Continuous Body Diode Current	۱ _s				7	А	
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			28		
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 3.5A, V _{GS} = 0V			1.4	V	
Reverse Recovery Time	t _{rr}	V _{GS} = 0V,I _S = 7A,		505		ns	
Reverse Recovery Charge	Q _{rr}	$di_F/dt = 100A /\mu s$		1.5		uC	

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 °C
- 3. Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 1%



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^{\circ}C$)

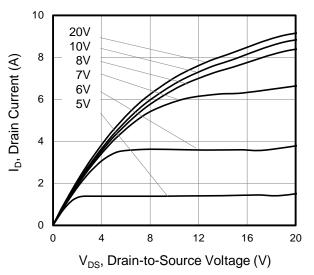
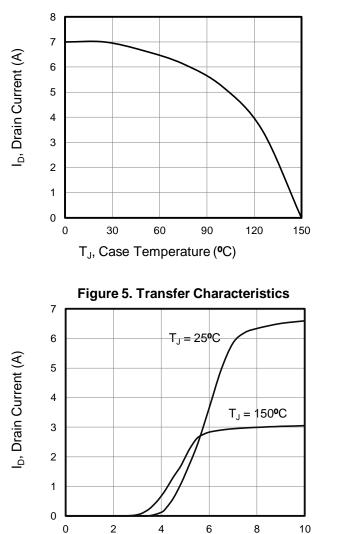


Figure 3. Drain Current vs. Temperature



V_{GS}, Gate-to-Source Voltage (V)

Figure 2. Body Diode Forward Voltage

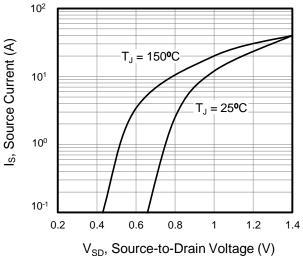


Figure 4. BV_{DSS} Variation vs. Temperature

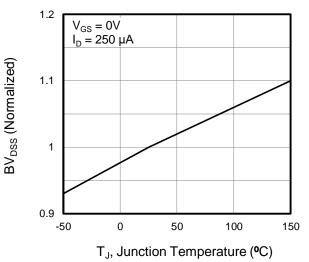
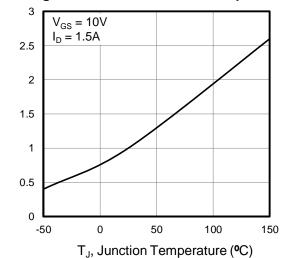


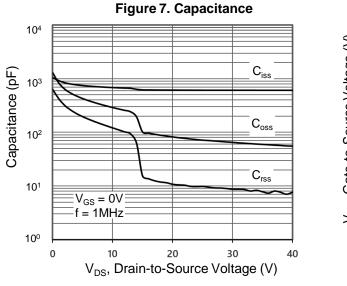
Figure 6. On-Resistance vs. Temperature

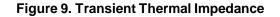


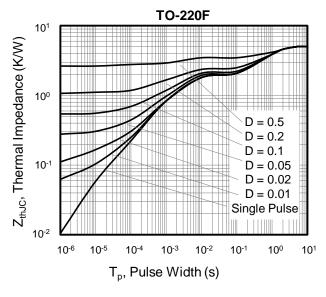
R_{DS(on)}, On-Resistance (Normalized)



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted







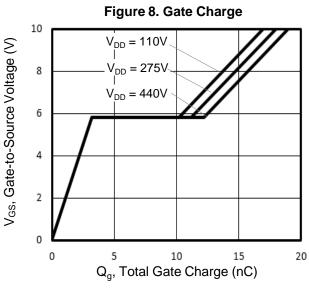
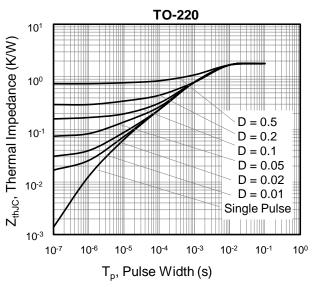


Figure 10. Transient Thermal Impedance





CS7N55F, CS7N55P



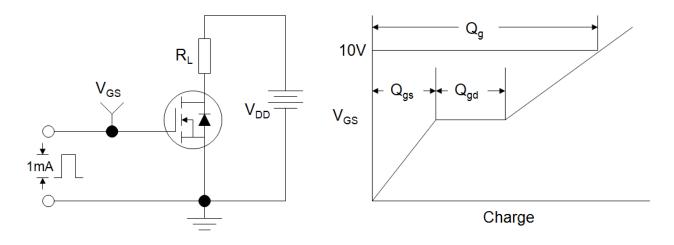


Figure B: Resistive Switching Test Circuit and Waveform

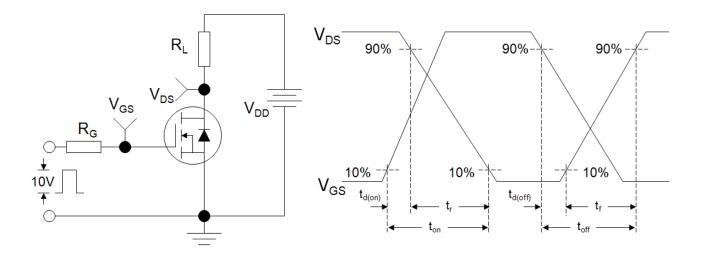
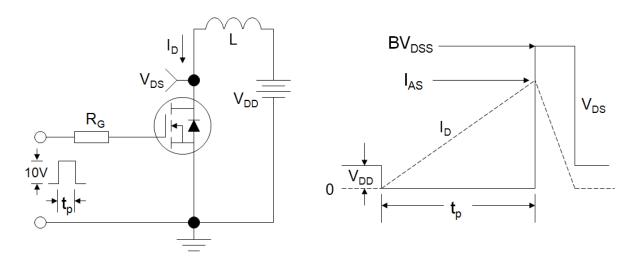
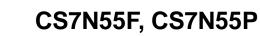


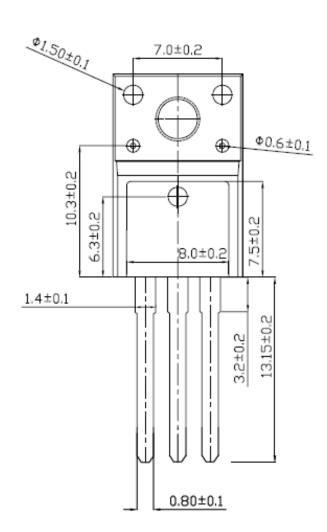
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

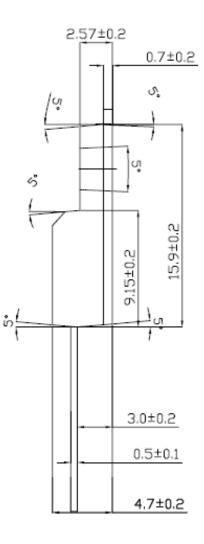






TO-220F

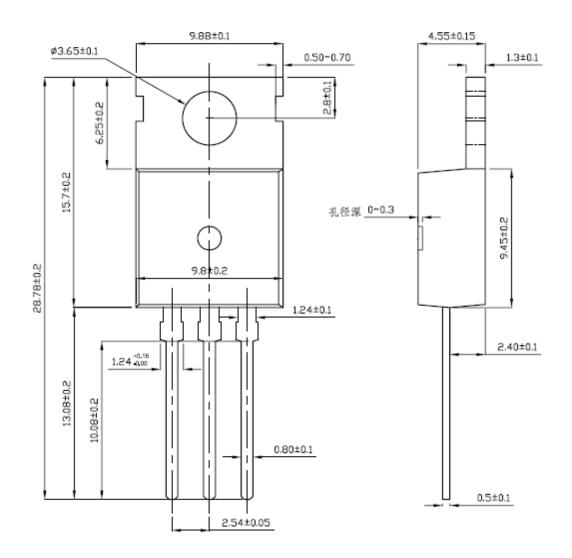








TO-220





Disclaimer

All product specifications and data are subject to change without notice.

For documents and material available from this datasheet, Suzhou Convert does not warrant or assume any legal liability or responsibility for the accuracy, completeness of any product or technology disclosed hereunder.

No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document or by any conduct of Suzhou Convert.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless. Customers using or selling Suzhou Convert products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Suzhou Convert for any damages arising or resulting from such use or sale.

Suzhou Convert disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Suzhou Convert's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

Suzhou Convert SemiConductor CO., Ltd. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all Suzhou Convert products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Suzhou Convert believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.